Detector Research and Development - DRD

international collaborations anchored at CERN: implementation

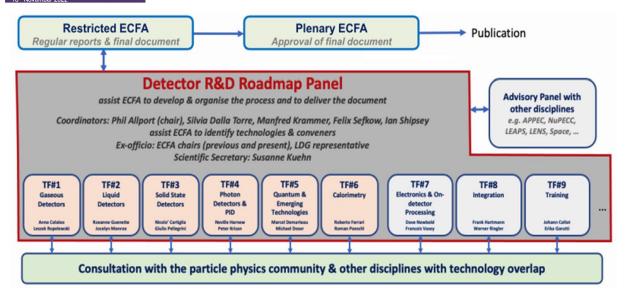


approved by CERN Council – coordinated by ECFA

ECFA Detector R&D Roadmap

RD51

- DRD1 Gaseous Detectors
- DRD2 Liquid Detectors
- DRD3 Solid State Detectors <<== RD50-42
- DRD4 Photon Detectors and PID
- DRD5 Quantum and Emerging Technologies
- DRD6 Calorimetry
- DRD7 Electronics and On-detector Processing
 RD53
- (DRD8 Integration) → Starting
- (DRD9 Training) → included in others / Starting







U.S. Detector R&D - CPAD

Coordinating Panel for Advanced Detectors

Marina Artuso Syracuse University

@ P5 Town Hall Meeting BNL April 12, 2023

Planning Detector Research Consortia

To sign up go to More Information

RD	Торіс	Mailing list	Current subscribers
RDC1	Noble elements Detectors	cpad_rdc1@fnal.gov	43
RDC2	Photodetectors	cpad_rdc2@fnal.gov	62
RDC3	Solid State Tracking	cpad_rdc3@fnal.gov	71
RDC4	Readout and ASICs	cpad_rdc4@fnal.gov	64
RDC5	Trigger and DAQ	cpad_rdc5@fnal.gov	28
RDC6	Gaseous Detectors	cpad_rdc6@fnal.gov	29
RDC7	Low-background detectors	cpad_rdc7@fnal.gov	38
RDC8	Quantum and Superconducting Sensors	cpad_rdc8@fnal.gov	62
RDC9	Calorimetry	cpad_rdc9@fnal.gov	46
RDC10	Detector Mechanics		JUST ADDED

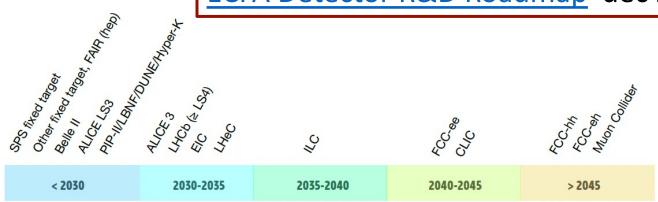
- Develop and maintain the critical and diverse technical workforce
- Double the US Detector R&D budget over the next five years, and modify existing funding models to enable R&D consortia along critical key technologies for the planned long-term science projects, sustaining the support for such collaborations for the needed duration and scale.

CPAD U.S. initiative

– new detector research consortia –

Picosecond timing across technologies consortium is under consideration

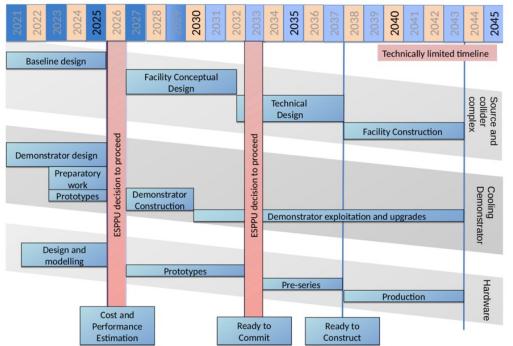
ECFA Detector R&D Roadmap dec 2021



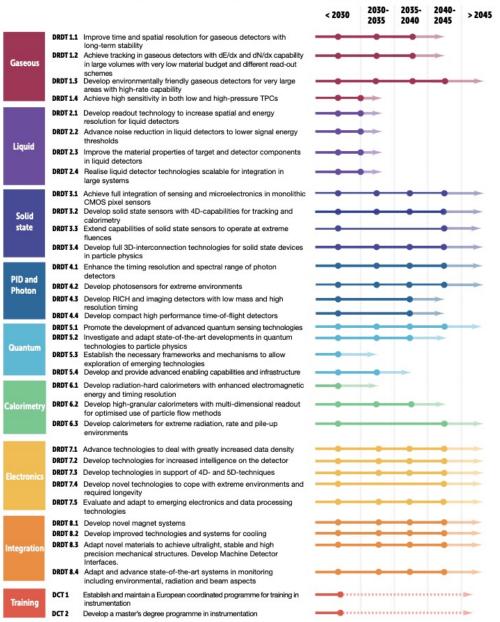




Accelerator R&D Roadmap dec 2021



DETECTOR RESEARCH AND DEVELOPMENT THEMES (DRDTs) & DETECTOR COMMUNITY THEMES (DCTs)



dates are	not known, t	he earliest	(This means, where the technically feasible start ctor R&D readiness is not		< 2030			2030-2035					2035 - 2040	2040-2045		> 2045				
the delayi		ear		Panda 2025	CBM 2025	NA62/Klever 2025	Belle II 2026	AUCE LS3 11	ALICE 3	LHCb (≳LS4) ¹⁾	ATLAS/CMS (≥ LS4) ¹¹	EIC	LHeC	ILC 2)	FCC-ee	CLIC 2)	FCC-hh	FCC-eh	Muon Collider	
			Position precision σ_{ht} (µm)		≃ 5		≲5	≃ 3	≲3	≲10	≲ 15	≲3	≃ 5	≲3	≲3	≲3	≃ 7	≃ 5	≲5	<u> </u>
			X/X ₀ (%/layer)	≲0.1	≃ 0.5	≃ 0.5	≲0.1	≃ 0.05	≃ 0.05	≃ 1		≃ 0.05	≲0.1	≃ 0.05	≃ 0.05	≲0.2	≃1	≲0.1	≲ 0.2	<u> </u>
*	MOS	DRDT 3.1 DRDT 3.4	Power (mW/cm²)		≃ 60			≃ 20	≃ 20			≃ 20		≃ 20	≃ 20	≃ 50				r
Vertex Detector ³	MAPS Planar/3D/Passive CMOS LGADs	9 9	Rates (GHz/cm²)		≃ 0.1	≃ 1	≲ 0.1		≲0.1	≃ 6		≲0.1	≃ 0.1	≃ 0.05	≃ 0.05	≃ 5	≃ 30	≃ 0.1		2
rex De	MAPS /3D/Passi LGADs		Wafers area (") ⁴⁾					12	12			12			12		12		12	1
> ×	Planar,	DRDT 3.2	Timing precision σ _t (ns) ^S	10		≲0.05	100		25	≲ 0.05	≲ 0.05	25	25	500	25	≃ 5	≲ 0.02	25	≲0.02	<
		DRDT3.3	Radiation tolerance NIEL (x 10 ¹⁶ neg/cm ²) Radiation tolerance TID							≃6 ≃1	≃ 2 ≃ 0.5						≃ 10 ² ≃ 30			
		7	(Grad) Position precision σ_{ht}						≃6	≃ 5	9850	≃6	≃ 6	≃ 6	≃6	≃ 7	= 10	≃6		-
			(µm) X/X ₀ (%/layer)						≃ 1	≃ 1		≃1	≃ 1	≃1	≃1	≃ 1	≲2	≃ 1	_	(
	501	DRDT 3.1 DRDT 3.4	Power (mW/cm²)						≲100	≃ 100		≲100		≲100	≲ 100	≲ 150		2005		١
ଜୁ	MAPS Planar/3D/Passive CMOS LGADs	ORO	Rates (GHz/cm²)							≃ 0.16										ر ا
Tracker [®]	MAPS 3D/Passi LGADs		Wafers area (") ⁴⁾						12			12		12	12	12	12		12	7
	lanar/:	DRDT 3.2	Timing precision σ _t (ns) ⁵						25	≲25		25	25	≲ 0.1	≲0.1	≲0.1	≲ 0.02	25	≲0.02	
	•	95	Radiation tolerance NIEL							≃ 0.3		20			×		≲1			2
		DRDT3.3	(x 10 ¹⁶ neq/cm ²) Radiation tolerance TID							≃ 0.25							≲1			ءُ ا
E	ssive	DRDT 3.2	(Grad) Timing precision $\sigma_t(ns)^{5}$					*						≲ 0.05	≲0.05	≲ 0.05	≲ 0.02		≲0.02	
Calorimeter ⁷⁾	MAPS r/3D/Pas IOS LGAD	m	Radiation tolerance NIEL	100					0								≥10			
Calor	MAPS Planar/3D/Passive CMOS LGADs	DRDT 3.	(x 10 ¹⁶ neq/cm ²) Radiation tolerance TID												7		≃ 50			2
₹_	sive	DRDT 3.2	(Grad) Timing precision σ _t (ns) ⁵				≃ 0.02		≃ 0.02		≲ 0.03	≃ 0.02	≃ 0.02		≲0.01		≲ 0.01	≃ 0.02		۶
Time of Flight ⁸¹	MAPS r/3D/Pas IOS LGAD		Radiation tolerance NIEL														≃ 10 ²		\vdash	,
Time o	MAPS Planar/3D/Passive CMOS LGADs	DRDT 3.3	(x 10 ¹⁶ neq/cm ²) Radiation tolerance TID												Ol .		≃ 30			
Malura	in direction of		(Grad)				D. The let			- 44			to codict		o salla la s	lianta aist		!+		1

Update from ECFA detector roadmap

> Last reference paper: <u>Towards a Muon Collider</u>

≤ 5

≤ 0.05

min possible

≈ 0.5

TBD best

≤ 0.03

 $\approx 0.1/y$

 $\approx 0.1/y$

7 tran / 90 long

0.2 total tracker

min possible

0.02

TBD best

≤ 0.06

 $\approx 0.01/y$

 $\approx 0.001/y$

< 0.2 arr / < 0.1 integ

 $\approx 0.05/y$

 $\approx 0.0001/y$

TOF not yet considered

Instrumentation R&D

- DOE Detector R&D BRN Report, Snowmass Instrumentation Report US;
- 2021 ECFA Detector R&D Roadmap Europe.

ECFA initiative to establish new detector R&D "groups" (DRD"X"). CPAD initiative planning new detector research consortia (RDC"X"). The two initiatives closely connect in structure and objectives.

RD	Topic					
RDC1	Noble elements Detectors					
RDC2	Photodetectors					
RDC3	Solid State Tracking					
RDC4	Readout and ASICs					
RDC5	Trigger and DAQ					
RDC6	Gaseous Detectors					
RDC7	Low-background detectors					
RDC8	Quantum and Superconducting Sensors					
RDC9	Calorimetry					
RDC10	Detector Mechanics					





Muon Collider Detector R&D

Solid-State Detectors (TF3/DRD3, RDC3)

- Radiation-hard silicon detectors with O(10ps) timing resolution
- Integrated or hybrid design

Calorimetry (TF6/DRD6, RDC9)

- High-granularity (transverse and longitudinal); good radiation hardness
- good timing resolution and low integration time (esp. ECAL)
- Scintillator or Silicon-based sampling; Crilin: semi-homogenous w/ SiPMs readout

Gaseous Detectors (TF1/DRD1, RDC6)

 Mostly Muon spectrometer: micromegas, GEM, etc.. focus on good timing resolution, sustainable gas mixtures

Photon-Detectors and PID (TF4/DRD4, RDC2)

- Less explored so far, but PID can offer additional physics oportunities
 Electronics (TF7/DRD7, RDC4)
- Radiation-hard ASIC design (HL-LHC levels)
- Small feature size for more complex on-chip processing (tracker, calo?)

Trigger and DAQ (RDC5)

Triggerless readout requires large real-time data handling

Detector Mechanics (RDC10)

Lightweight structures, nozzle support design,